Description

The series of devices uses **Super Trench II** technology that is uniquely optimized to provide the most efficient high frequency switching performance. Both conduction and switching power losses are minimized due to an extremely low combination of $R_{DS(ON)}$ and Q_g. This device is ideal for high-frequency switching and synchronous rectification.

Application

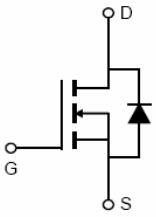
- DC/DC Converter
- Ideal for high-frequency switching and synchronous rectification

General Features

- V_{DS} =120V,I_D =90A
  $R_{DS(ON)}$=7.7mΩ , typical (TO-220)@ V_{GS}=10V
  $R_{DS(ON)}$=7.5mΩ , typical (TO-263)@ V_{GS}=10V
- Excellent gate charge x $R_{DS(on)}$ product(FOM)
- Very low on-resistance $R_{DS(on)}$
- 175 °C operating temperature
- Pb-free lead plating

TO-263

TO-220C



Schematic Diagram

Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
VST12N077-T3	VST12N077	TO-220C	-	-	-
VST12N077-TC	VST12N077	TO-263	-	-	-

Absolute Maximum Ratings (T_C=25℃unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V_{DS}	120	V
Gate-Source Voltage	V_{GS}	±20	V
Drain Current-Continuous	I_D	90	A
Drain Current-Continuous(T_C=100℃)	I_D (100℃)	64	A
Pulsed Drain Current(Note 1)	I_{DM}	360	A
Maximum Power Dissipation	P_D	140	W
Derating factor		0.93	W/℃
Single pulse avalanche energy (Note 4)	E_{AS}	352	mJ
Operating Junction and Storage Temperature Range	T_J,T_{STG}	-55 To 175	℃

Thermal Characteristic

Thermal Resistance,Junction-to-Case	$R_{\theta JC}$	1.07	℃/W

Electrical Characteristics (T_C=25℃unless otherwise noted)

Parameter	Symbol	Condition		Min	Typ	Max	Unit
Off Characteristics							
Drain-Source Breakdown Voltage	BV_{DSS}	V_{GS}=0V I_D=250μA		120		-	V
Zero Gate Voltage Drain Current	I_{DSS}	V_{DS}=120V,V_{GS}=0V		-	-	1	μA
Gate-Body Leakage Current	I_{GSS}	V_{GS}=±20V,V_{DS}=0V		-	-	±100	nA
On Characteristics (Note 3)							
Gate Threshold Voltage	$V_{GS(th)}$	V_{DS}=V_{GS}, I_D=250μA		2.0	3.0	4.0	V
Drain-Source On-State Resistance	$R_{DS(ON)}$	V_{GS}=10V, I_D=45A	TO-220	-	7.7	8.0	mΩ
			TO-263		7.5	8.0	
Forward Transconductance	g_{FS}	V_{DS}=5V,I_D=45A			55	-	S
Dynamic Characteristics (Note3)							
Input Capacitance	C_{lss}	V_{DS}=60V,V_{GS}=0V, F=1.0MHz		-	3715	-	pF
Output Capacitance	C_{oss}			-	275	-	pF
Reverse Transfer Capacitance	C_{rss}			-	18	-	pF
Switching Characteristics (Note 3)							
Turn-on Delay Time	$t_{d(on)}$	V_{DD}=60V,I_D=45A V_{GS}=10V,R_G=1.6Ω		-	20	-	nS
Turn-on Rise Time	t_r			-	16	-	nS
Turn-Off Delay Time	$t_{d(off)}$			-	45	-	nS
Turn-Off Fall Time	t_f			-	12	-	nS
Total Gate Charge	Q_g	V_{DS}=60V,I_D=45A, V_{GS}=10V		-	58	-	nC
Gate-Source Charge	Q_{gs}			-	21	-	nC
Gate-Drain Charge	Q_{gd}			-	14.5	-	nC
Drain-Source Diode Characteristics							
Diode Forward Voltage (Note 2)	V_{SD}	V_{GS}=0V,I_S=45A		-	-	1.2	V
Diode Forward Current	I_S			-	-	90	A
Reverse Recovery Time	t_{rr}	T_J = 25°C, I_F = 90A di/dt = 100A/μs (Note3)		-	65	-	nS
Reverse Recovery Charge	Qrr			-	105	-	nC

Notes:

1. Repetitive Rating: Pulse width limited by maximum junction temperature.
2. Pulse Test: Pulse Width ≤ 300μs, Duty Cycle ≤ 2%.
3. Guaranteed by design, not subject to production
4. EAS condition : Tj=25℃,V_{DD}=50V,V_G=10V,L=0.25mH,Rg=25Ω

Typical Electrical and Thermal Characteristics

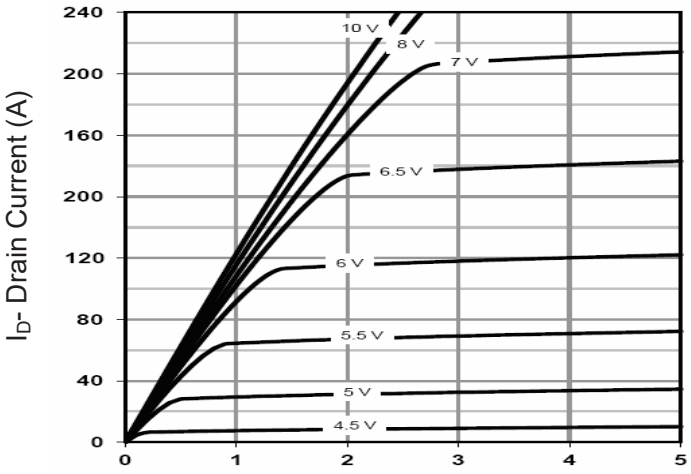


Figure 1 Output Characteristics

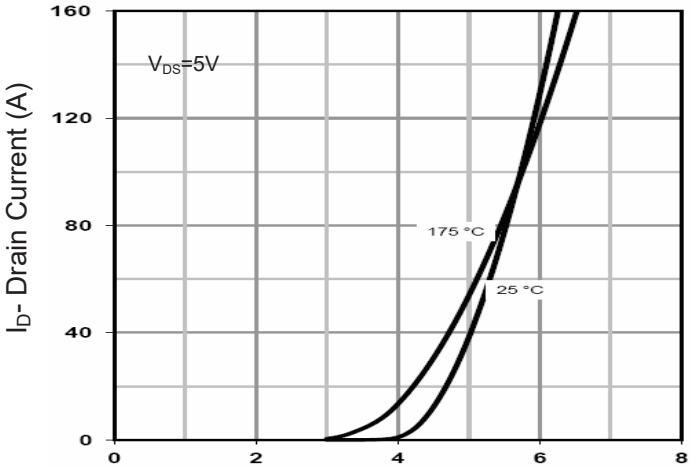


Figure 2 Transfer Characteristics

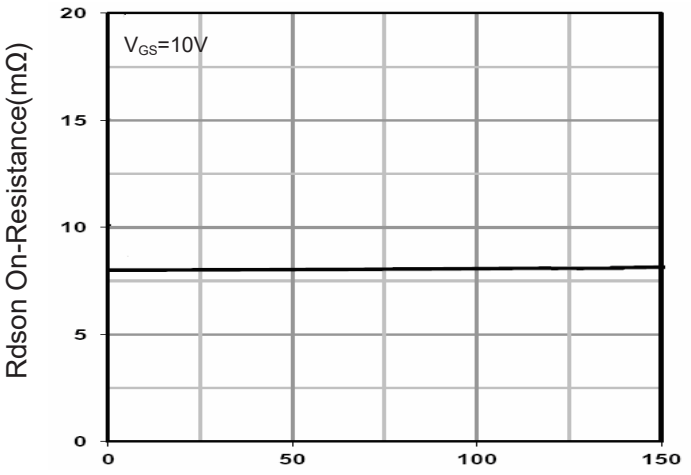


Figure 3 Rdson-Junction Temperature

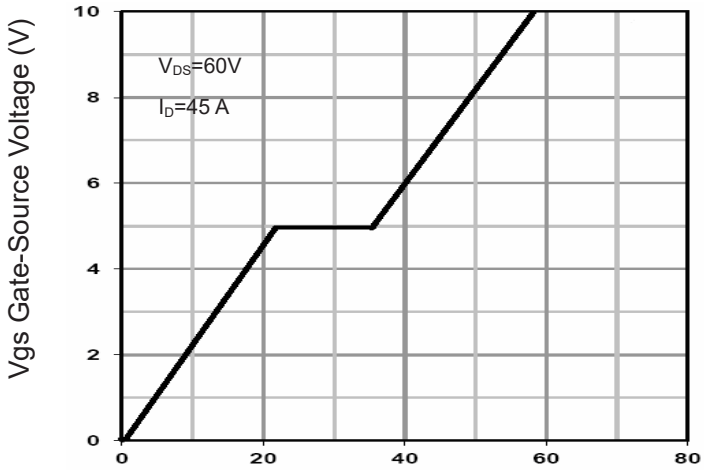


Figure 4 Gate Charge

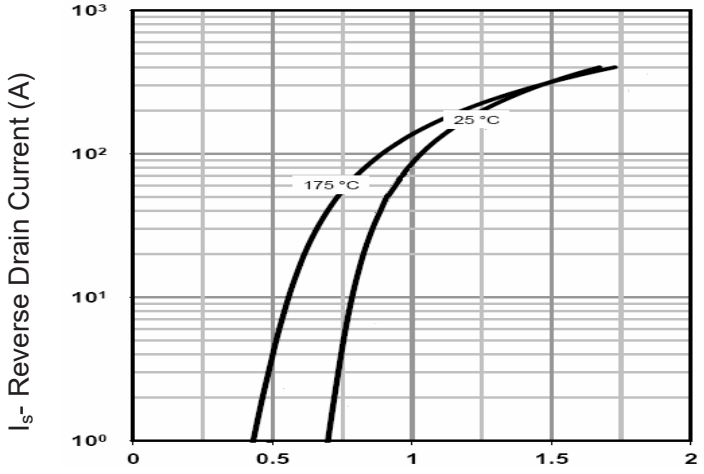


Figure 5 Source- Drain Diode Forward

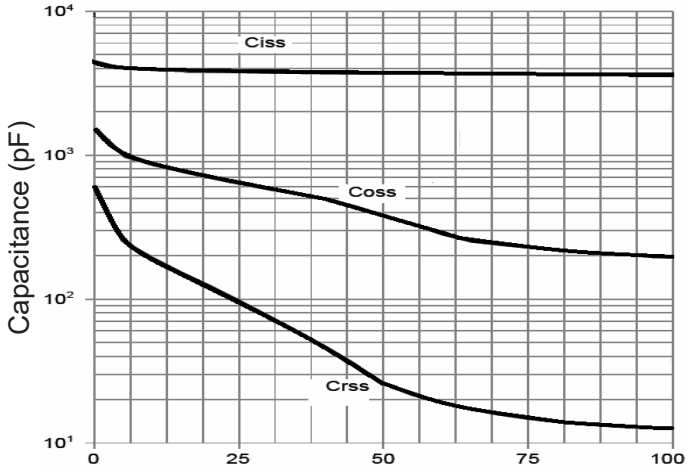


Figure 6 Capacitance vs Vds

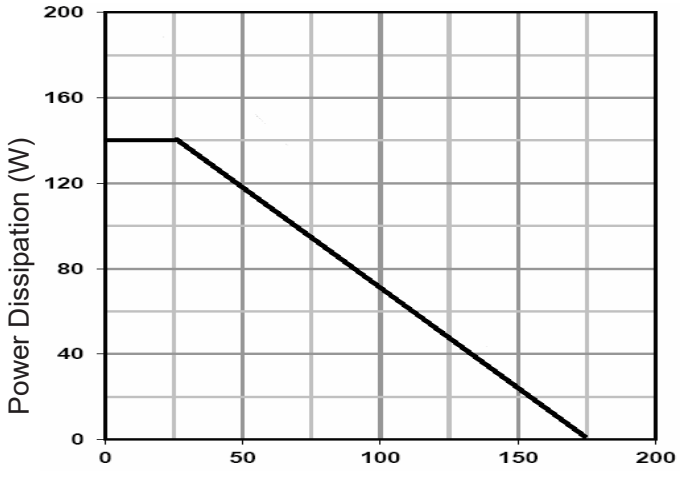


Figure 7 Power De-rating

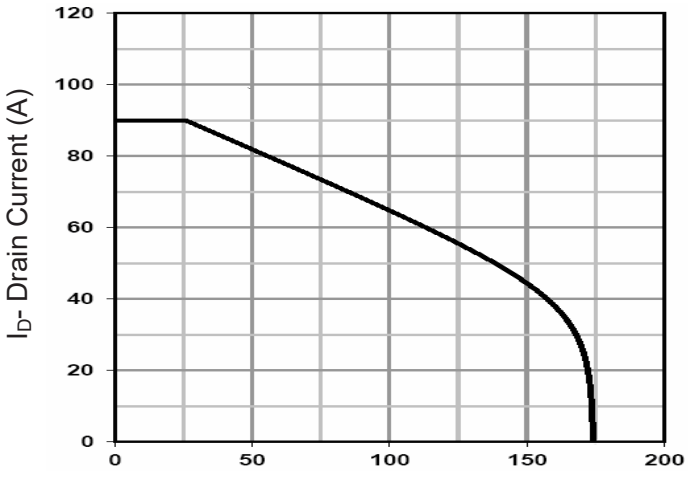


Figure 9 Current De-rating

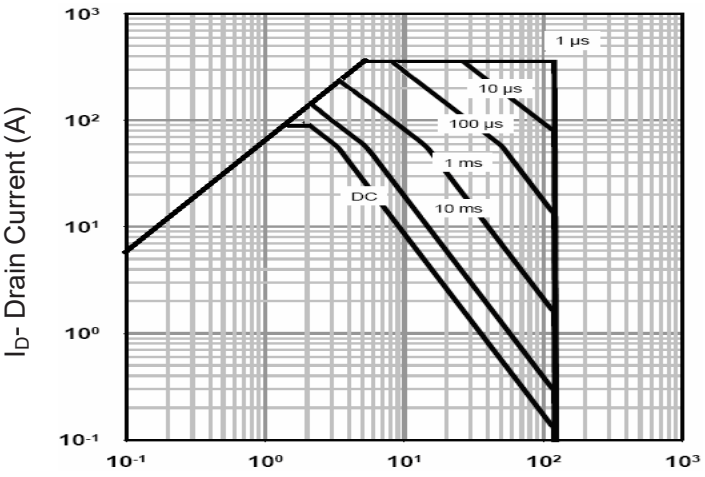


Figure 8 Safe Operation Area

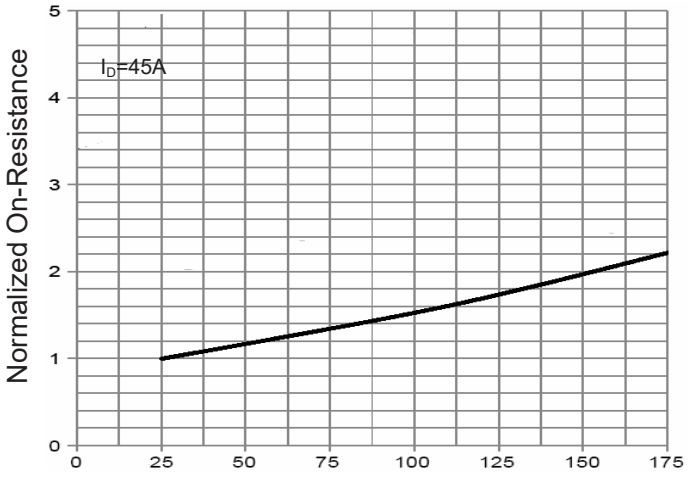


Figure 10 Rdson-Junction Temperature

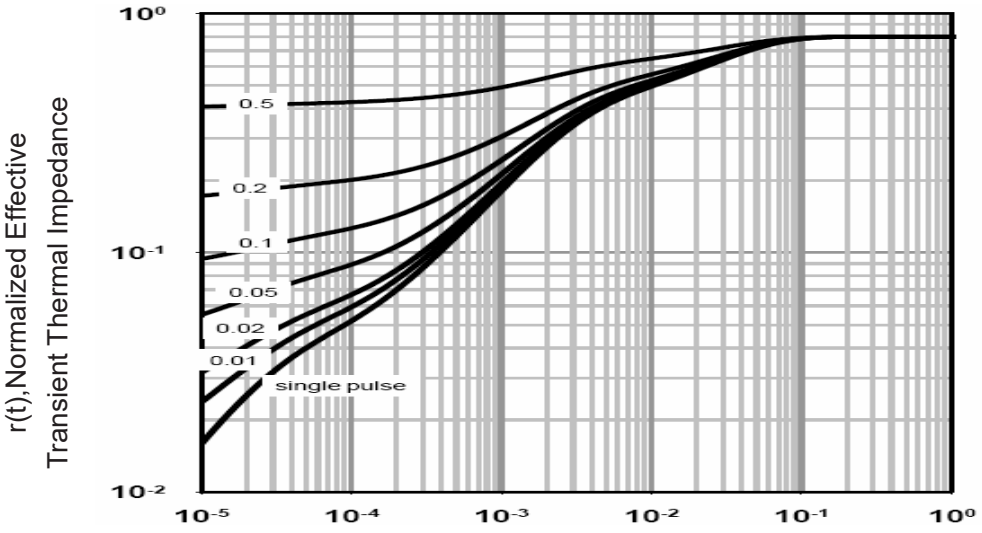


Figure 11 Normalized Maximum Transient Thermal Impedance